BYV29 series

GENERAL DESCRIPTION

Glass passivated, high efficiency, rectifier diodes in a plastic envelope featuring low forward voltage drop, ultra fast reverse recovery times and soft recovery characteristic. They are intended for use in switched mode power supplies and high frequency circuits in general, where both low conduction losses and low switching losses are essential.

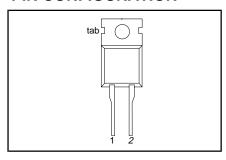
QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	MAX.	MAX.	UNIT
V _{RRM}	BYV29- Repetitive peak reverse voltage	300 300	400 400	500 500	V
$\begin{bmatrix} V_{F} \\ I_{F(AV)} \\ t_{rr} \end{bmatrix}$	Forward voltage Average forward current Reverse recovery time	1.03 9 60	1.03 9 60	1.03 9 60	V A ns

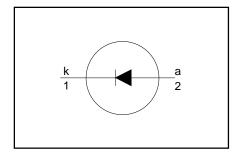
PINNING - TO220AC

PIN	DESCRIPTION		
1	cathode (k)		
2	anode (a)		
tab	cathode (k)		

PIN CONFIGURATION



SYMBOL



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.		UNIT	
V _{RRM} V _{RWM} V _R	Repetitive peak reverse voltage Crest working reverse voltage Continuous reverse voltage			-300 300 300 300	-400 400 400 400	-500 500 500 500	>>>
I _{F(AV)}	Average forward current ¹	square wave; $\delta = 0.5$; $T_{mb} \le 123 ^{\circ}\text{C}$	-		9		А
		sinusoidal; a = 1.57; T _{mb} ≤ 125 °C	-		8		A
I _{F(RMS)}	RMS forward current		-		13		A
I _{FRM}	Repetitive peak forward current	$t = 25 \mu s$; $δ = 0.5$; $T_{mb} \le 123 °C$	-		18		Α
I _{FSM}	Non-repetitive peak forward	t = 10 ms	-		100		A
. 5	current.	t = 8.3 ms sinusoidal; with reapplied	-		110		A
l ² t	I ² t for fusing	$V_{RRM(max)}$ t = 10 ms	_		50		A ² s
1 🛨	Storage temperature	- 10 1115	-40		150		Ç
T_{j}^{stg}	Operating junction temperature		-40		150		, C

August 1996 1 Rev 1.200

¹ Neglecting switching and reverse current losses.

BYV29 series

THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
R _{th j-mb}	Thermal resistance junction to mounting base		-	-	2.5	K/W
R _{th j-a}		in free air.	-	60	-	K/W

STATIC CHARACTERISTICS

T_i = 25 °C unless otherwise stated

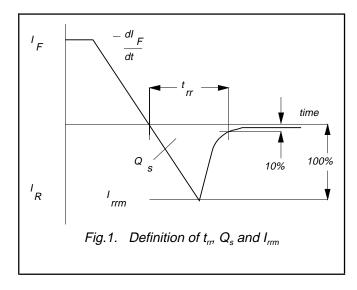
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V_{F}	Forward voltage	$I_{\rm F} = 8 \text{ A}; T_{\rm i} = 150^{\circ}\text{C}$	-	0.90	1.03	V
	_	$I_F = 8 \text{ A}$	-	1.05	1.25	V
		$I_{\rm F} = 20 \text{ A}$	-	1.20	1.40	V
I _R	Reverse current	$V_R = V_{RRM}$	-	2.0	50	μΑ
		$V_{R} = V_{RRM}$; $T_{j} = 100 ^{\circ}C$	-	0.1	0.35	mΑ

DYNAMIC CHARACTERISTICS

 $T_i = 25$ °C unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Q_s	Reverse recovery charge	$I_F = 2 \text{ A to } V_R \ge 30 \text{ V};$ $dI_F/dt = 20 \text{ A/}\mu\text{s}$	1	40	60	nC
t _{rr}	Reverse recovery time	$I_F = 1 \text{ A to } V_R \ge 30 \text{ V};$ $dI_F/dt = 100 \text{ A/}\mu\text{s}$	-	50	60	ns
I _{rrm}	Peak reverse recovery current	$I_F = 10 \text{ A to } V_R \ge 30 \text{ V};$ $dI_F/dt = 50 \text{ A/}\mu\text{s}; T_i = 100^{\circ}\text{C}$	-	4.0	5.5	Α
V_{fr}	Forward recovery voltage	$I_F = 10 \text{ A}; \text{ d}I_F/\text{d}t = 10 \text{ A}/\mu\text{s}$	-	2.5	-	V

BYV29 series



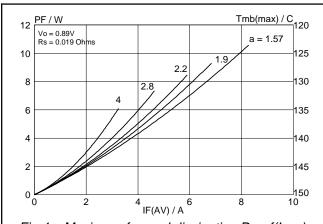
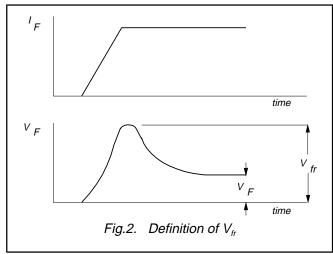
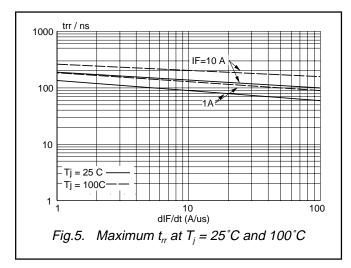
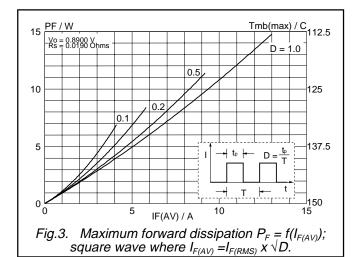
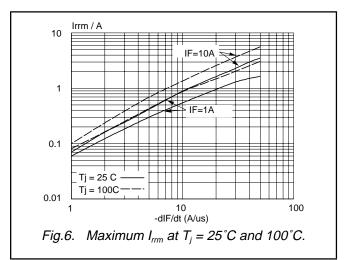


Fig.4. Maximum forward dissipation $P_F = f(I_{F(AV)})$; sinusoidal current waveform where a = form factor = $I_{F(RMS)} / I_{F(AV)}$.









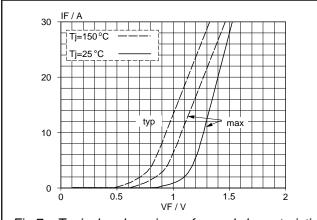
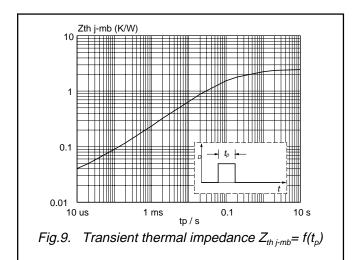
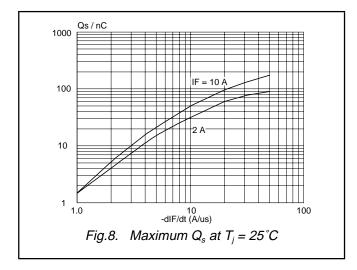


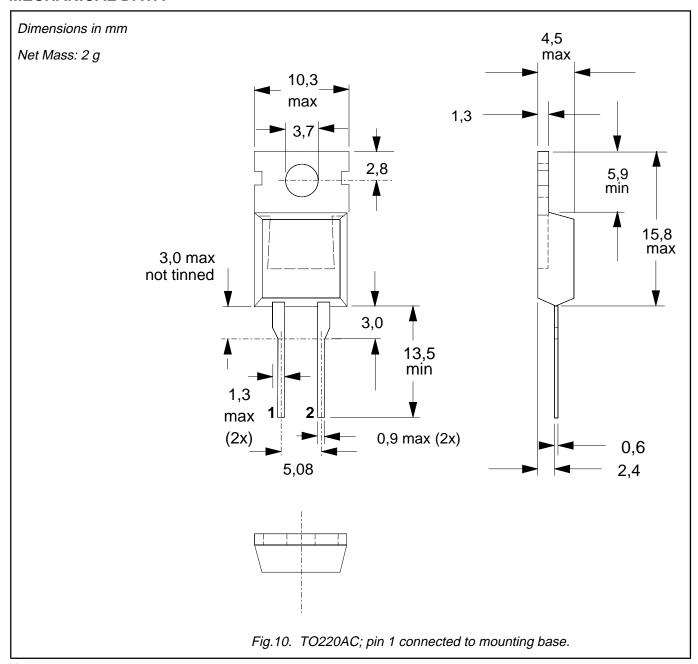
Fig.7. Typical and maximum forward characteristic $I_F = f(V_F)$; parameter T_j





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MECHANICAL DATA



- Notes
 1. Refer to mounting instructions for TO220 envelopes.
 2. Epoxy meets UL94 V0 at 1/8".

BYV29 series

DEFINITIONS

Data sheet status					
Objective specification	This data sheet contains target or goal specifications for product development.				
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.				
Product specification	This data sheet contains final product specifications.				
	•				

Limiting values

Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information

Where application information is given, it is advisory and does not form part of the specification.

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